IPC ASSOCIATION ELECTRONIE	Material Composition Declaration © Copyright 2005. IPC, Bannockburn, Illinois. All rights reserved under both international and Pan-American copyright conventions.				nder both	This document is a declaration of the substances within the manufacturer listed item. Note: if the item is an assembly with lower level parts, the declaration encompasses all lower level materials for which the manufacturer has engineering responsibility.									
1752-21.1					Form Type * Distribute	Declaration Class * Class 6 - RoHS Yes/No, Homogeneous Mater					ials and Mfg Information				
Supplie	r Information														
Company name* Company ur				unique ID t			Unique ID Authority					Response Date*			
n Semic	onductor											2021-02-04			
Contact N	Vame	Title - Conta	Title - Contact			Phone - Contact*					Email - Contact*				
Product-l	Env-Stewards		Product Env	Product Enviro Compliance			NA					Product-Env-Stewards@onsemi.com			
uthorize	ed Representative*	Title - Representative				Phone - Representative*				Email - Representative*					
Product-	Env-Stewards	Product Enviro Compliance				NA				Product-Env-Stewards@onsemi.com					
	Requester Item Number Mfr Item MJH628		Number Mfr Item Name				Effective Date Version Manufacturing S.		g Site	W	eight*	UOM	Unit Type		
			7	BIP T0218 PNP 20A 100V			2021-02-04		4		4000.01		00.01	mg	Each
Ianufa	acturing Process Information							1							
			· · · · · · · · · · · · · · · · · · ·		-STD-020 MSL	Rating			ly Temperati	perature Max Time at Peak				er of Reflow Cyc	eles
PbSn		CU Alloy NA			0 C 30				seconds 3						
omments	8														
or more	information regarding materia	l composition	please refer t	o page 3											

RoHS Material Composition Declaration			Declaration Type *	Detailed							
RoHS Definition: Quantity limit of 0.01% by mass (100 PPM) in homogeneous material for Cadmium and quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead (Pb), Mercury (Hg), Hexavalent Chromium (Cr6+), Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE), and Bis(2-ethylhexyl) phthalate (DEHP), Benzyl-butyl phthalate (BBP), Dibutyl phthalate (DBP), Diisobutyl phthalate (DIBP).											
cadmium, hexavalentchromium, polybromina contains a RoHS restricted substance inexces encompass all such components. Supplier cert as of the date that Supplier completes this for Company acknowledges that Supplier may be independently verified information provided certification in this paragraph. If the Company that agreement, will be the sole and exclusive	ted biphenyls and/or polybrominated diphenyl es of an applicable quantity limit, please indicate ifies that it gathered the information it provides m. Supplier acknowledges that Company will relive relied on informationprovided by others in c by others, Supplier agrees that, at a minimum, it and the Supplier enter into a written agreement	011/65/EU and implemented by the laws of the Euchters (each a "RoHS restricted substance") in excluded which, if any, RoHS exemption you believ in this form using appropriate methods to ensure itly on this certification in determining the compliant completing this form, and that Supplier may not has the suppliers have provided certifications regarding the with respect to the identified part, the terms and county's remedies for issues that arise regarding information to such part shall apply.	ess of the applicable quantity limit identified above may apply. If the part is an assembly with lowests accuracy and that such information is true and the compact of its products with European Union members with the part, and those certifications to the part, and those certification oditions of that agreement, including any warrance.	ove. If a homogeneous material within the part er level components, the declaration shall correct to the best of its knowledge and belief, r state laws that implement the RoHS Directive. wever, in situations where Supplier has not tions are at least as comprehensive as the unty rights and/or remedies provided as part of							
RoHS Declaration * 5 - Item(s	s) is obsolete, no information is available		Supplier Acceptance	* Accepted							
Exemption: If the declared item does not contain RoHS restricted substances per the definition above except for defined RoHS exemptions, then select the corresponding response in the RoHS Declaration above and choose all applicable exemptions.											
Exemption List Version	EL-2011/534/EU										
Declaration Signature											
Instructions: Complete all of the required	fields on all pages of this form. Select the "Ac	cented" on the Supplier Acceptance dron-down	n This will display the signature area Digital	ly sign the declaration (if required by the							
Instructions: Complete all of the required Requester) and click on Submit Form to ha	fields on all pages of this form. Select the "Acave the form returned to the Requester.	ccepted" on the Supplier Acceptance drop-down	n. This will display the signature area. Digital	ly sign the declaration (if required by the							

Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Substance Instructions: [A] select the Level (JIG A, JIG B, Requester or Supplier) [B] select the substance category (JIG or Requester) or enter a value (Supplier). [C] select the substance (JIG) or enter the substance and CAS (Other). [D] select a RoHS exemption, if applicable [E] enter the weight of the substance or the PPM concentration [F] Optionally enter the positive (+) and negative (-) tolerance in percent (Note: percent tolerance values are expected to cover a 3 sigma range of distribution unless otherwise noted).

Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure
Die	80.2	mg	Supplier	Silicon (Si)	7440-21-3		80.2	mg
Die Attach	52.96	mg	A	Lead (Pb)	7439-92-1		50.312	mg
			Supplier	Tin (Sn)	7440-31-5		2.648	mg
Lead Frame	829.74	mg	Supplier	Zinc (Zn)	7440-66-6		4.1487	mg
			В	Nickel (Ni)	7440-02-0		428.1458	mg
			Supplier	Copper (Cu)	7440-50-8		397.4455	mg
Mold Compound-Black	2140.08	mg		Brominated epoxy resin	proprietary data		64.2024	mg
			Supplier	Phenolic Resin	Proprietary Data		143.3854	mg
			В	Antimony Trioxide (Sb2O3)	1309-64-4		27.821	mg
			Supplier	Fused Silica (SiO2)	60676-86-0		1620.0405	mg
			Supplier	Ortho Cresol Novolac Resin	29690-82-2		284.6306	mg
Plating	241.23	mg	A	Lead (Pb)	7439-92-1		48.246	mg
			Supplier	Tin (Sn)	7440-31-5		192.984	mg
Wire Bond - Al	655.8	mg	Supplier	Aluminum (Al)	7429-90-5		655.8	mg